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## FAIRCHILD

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## FDS4435BZ\_F085 P-Channel PowerTrench<sup>®</sup> MOSFET -30V, -8.8A, 20mΩ

## Features

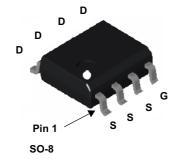
- Max  $r_{DS(on)}$  = 20m $\Omega$  at V<sub>GS</sub> = -10V, I<sub>D</sub> = -8.8A
- Max  $r_{DS(on)}$  = 35m $\Omega$  at V<sub>GS</sub> = -4.5V, I<sub>D</sub> = -6.7A
- Extended V<sub>GSS</sub> range (-25V) for battery applications
- HBM ESD protection level of ±3.8KV typical (note 3)
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability
- Termination is Lead-free and RoHS compliant
- Qualified to AEC Q101

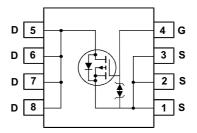




## **General Description**

This P-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.





## **MOSFET Maximum Ratings** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter Drain to Source Voltage			Ratings	Units V
V <sub>DS</sub>				-30	
V <sub>GS</sub>	Gate to Source Voltage			±25	V
I <sub>D</sub>	Drain Current -Continuous	T <sub>A</sub> = 25°C	(Note 1a)	-8.8	
	-Pulsed			-50	Α
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.5	14/
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1b)	1.0	W
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 4)	24	mJ
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperation	ature Range		-55 to +150	°C

## **Thermal Characteristics**

$R_6$	JC	Thermal Resistance, Junction to Case	25	°C/W	
$R_{6}$	ЭJA	Thermal Resistance, Junction to Ambient (Note 1a)	50	C/W	

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS4435BZ	FDS4435BZ_F085	SO-8	13"	12mm	2500units

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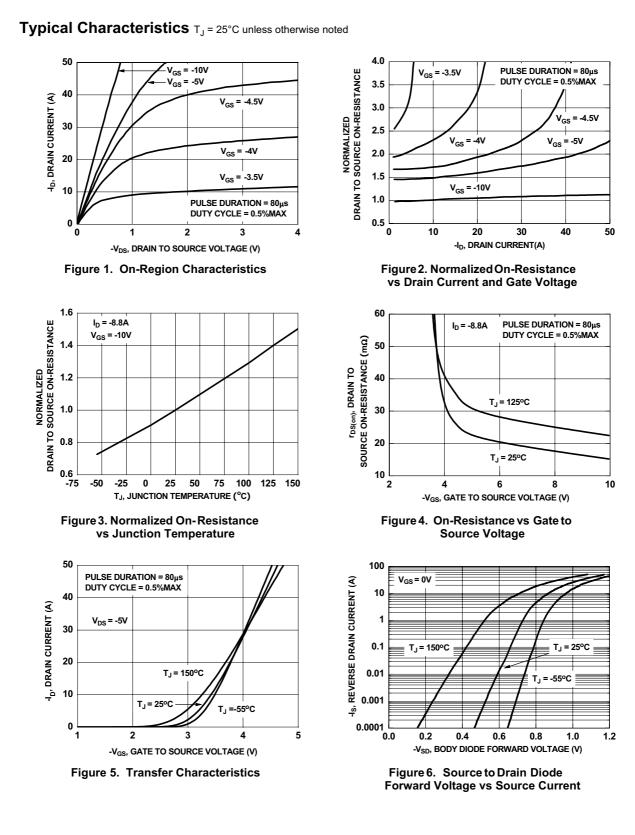
Off Charac BV <sub>DSS</sub> <u>ABV<sub>DSS</sub></u> AT <sub>J</sub> I <sub>DSS</sub> I <sub>GSS</sub>			Min	Тур	Max	Units
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$						
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Drain to Source Breakdown Voltage	$I_{D} = -250 \mu A, V_{GS} = 0 V$	-30			V
ΔT <sub>J</sub> I <sub>DSS</sub>	Breakdown Voltage Temperature			-21		mV/°C
	Coefficient	$I_D$ = -250µA, referenced to 25°C		-21		mV/°C
lass	Zero Gate Voltage Drain Current	$V_{DS} = -24V,  V_{GS} = 0V$			1	μA
000	Gate to Source Leakage Current	$V_{GS}$ = ±25V, $V_{DS}$ = 0V			±10	μA
On Charac	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-2.1	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \mu A$ , referenced to 25°C		6		mV/°C
5	- P	V <sub>GS</sub> = -10V, I <sub>D</sub> = -8.8A		16	20	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = -4.5V, I_D = -6.7A$		26	35	mΩ
		V <sub>GS</sub> = -10V, I <sub>D</sub> = -8.8A, T <sub>J</sub> = 125°C		22	28	1
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = -5V, I <sub>D</sub> = -8.8A		24		S
Dynamic (	Characteristics					
C <sub>iss</sub>	Input Capacitance			1385	1845	pF
C <sub>oss</sub>	Output Capacitance	$-V_{DS} = -15V, V_{GS} = 0V,$		275	365	pF
	Reverse Transfer Capacitance	f = 1MHz		230	345	pF
Crss						
R <sub>g</sub>	Gate Resistance Characteristics	f = 1MHz		4.5		Ω
R <sub>g</sub> Switching t <sub>d(on)</sub> t <sub>r</sub>	Characteristics Turn-On Delay Time Rise Time	f = 1MHz V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6	20 12	ns ns
Rg <b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A,		10 6 30	12 48	ns ns ns
R <sub>g</sub> <b>Switching</b> t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6 30 12	12 48 22	ns ns ns ns
$\frac{R_g}{\textbf{Switching}}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $Q_g$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6 30 12 28	12 48 22 40	ns ns ns ns nC
$\begin{array}{c} & \\ t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_g \\ Q_g \end{array}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A,		10 6 30 12 28 16	12 48 22	ns ns ns nC nC
Rg           Switching           t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> Q <sub>g</sub> Q <sub>gs</sub>	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6 30 12 28 16 5.2	12 48 22 40	ns ns ns nC nC nC
$\frac{R_g}{switching}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_g}$ $\frac{Q_{gs}}{Q_{gd}}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6 30 12 28 16	12 48 22 40	ns ns ns nC nC
$\frac{R_g}{Switching}$ $\frac{t_{d(on)}}{t_r}$ $\frac{t_{d(off)}}{t_f}$ $\frac{Q_g}{Q_g}$ $\frac{Q_{gs}}{Q_{gd}}$ Drain-Sou	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$V_{DD} = -15V, I_{D} = -8.8A,$ $V_{GS} = -10V, R_{GEN} = 6\Omega$ $V_{GS} = 0V \text{ to } -10V$ $V_{GS} = 0V \text{ to } -5V$ $V_{DD} = -15V,$ $I_{D} = -8.8A$		10 6 30 12 28 16 5.2	12 48 22 40	ns ns ns nC nC nC
$\frac{R_{g}}{Switching}$ $\frac{t_{d(on)}}{t_{r}}$ $\frac{t_{d(off)}}{d_{g}}$ $\frac{Q_{g}}{Q_{gs}}$ $\frac{Q_{gd}}{Q_{gd}}$	Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge rce Diode Characteristics	V <sub>DD</sub> = -15V, I <sub>D</sub> = -8.8A, V <sub>GS</sub> = -10V, R <sub>GEN</sub> = 6Ω		10 6 30 12 28 16 5.2 7.4	12 48 22 40 23	ns ns ns nC nC nC

2. Pulse Test: Pulse Width <  $300\mu$ s, Duty cycle < 2.0%.

3. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.

4. Starting  $T_J$  = 25°C, L = 1mH,  $I_{AS}$  = -7A,  $V_{DD}$  = -30V,  $V_{GS}$  = -10V

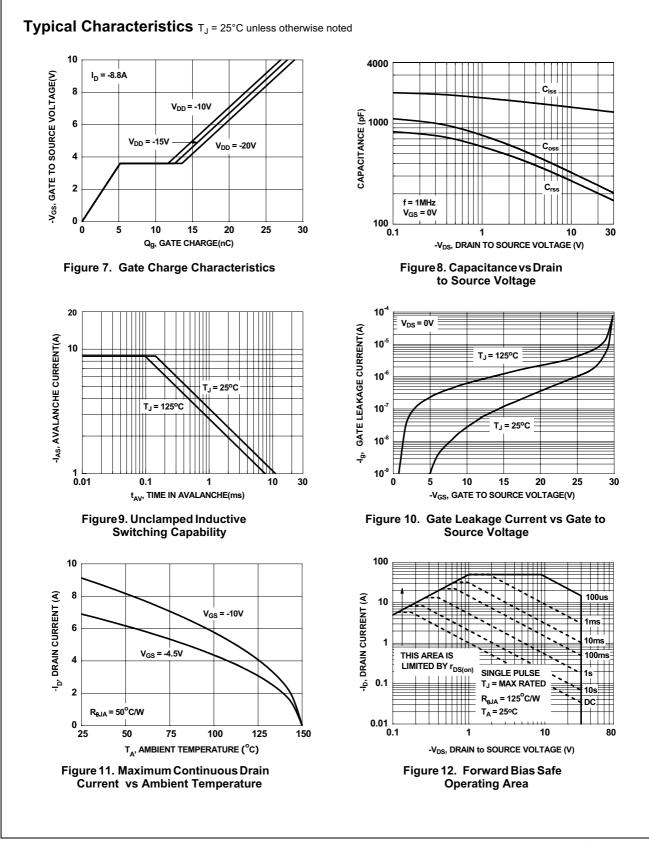
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FDS4435BZ\_F085 P-Channel PowerTrench<sup>®</sup> MOSFET

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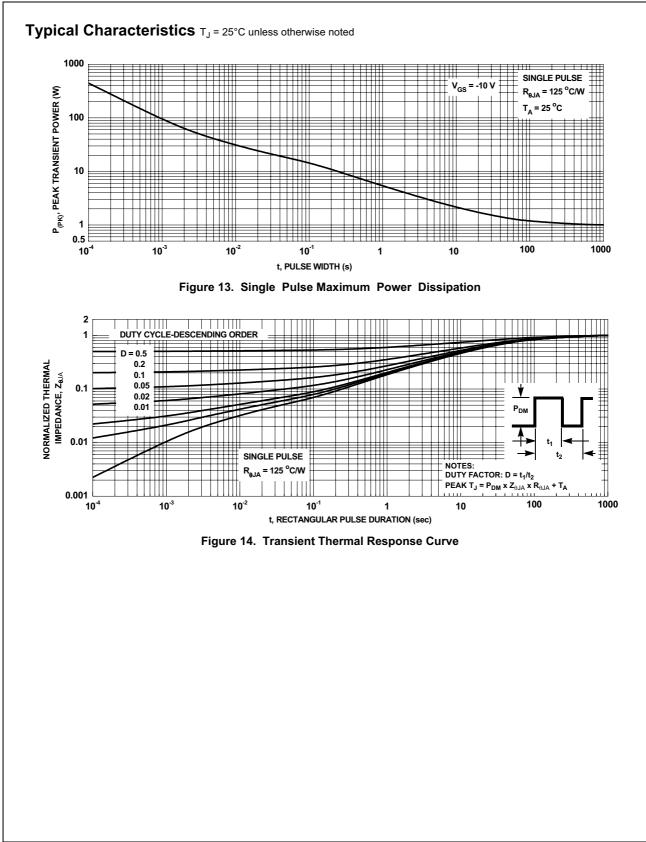
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